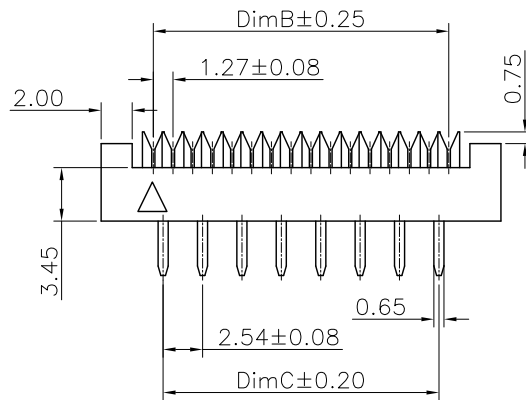
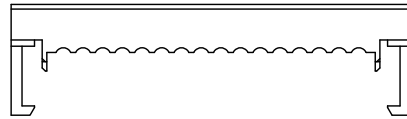
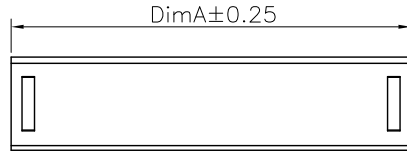
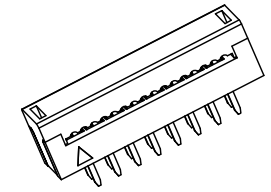


PCB Layout



Specifications:

Current rating:1.0A AC,DC

Voltage rating:30V AC, DC

Contact tesistance:20m ohm Max

Insulation resistance:1,000M ohm Min

Withstanding voltage:500V AC/minute

Operating Temperature:-40°C ~ +105°C

Material:

Insulator:PBT UL94V-0

Coctact:Copper Alloy

Plating:Selective Gold Plated or Tin Plated

How To Order

4403-XXX

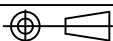
Blank Selective Gold Plated

T: Tin Plated

No. Of Positions

Pos.	Dim. A	Dim. B	Dim. C	Pos.	Dim. A	Dim. B	Dim. C
6	13.07	6.35	5.08	26	38.47	31.75	30.48
8	15.61	8.89	7.62	30	43.55	36.83	35.56
10	18.15	11.43	10.16	34	48.63	41.91	40.64
12	20.69	13.97	12.70	36	51.17	44.45	43.18
14	23.23	16.51	15.24	40	56.25	49.53	48.26
16	25.77	19.05	17.78	50	68.95	62.23	60.96
18	28.31	21.59	20.32	60	81.65	74.93	73.66
20	30.85	24.13	22.86	64	86.73	80.01	78.74
24	35.93	29.21	27.94				

RoHS Compliant

F				DRAWN:	GENERAL TOLERANCE:	 Neltron Industrial Co., Ltd.	
E				Jamie Wang	.X=±0.20 .XX=±0.15		
D				CHECKED:	UNIT: MM	DESCRIPTION: 2.54mm IDC Pulg Dip Type	
C				Jerry Chen	SCALE: 1:1		
B				APPROVAL:	SHEET: 1 / 1	PART NO: 4403-XXX	
A	15-Nov-2016	(P0001)	Jamie Wang	Mike Wu	PROJECTION: 		
REV	DATE	FILE	BY				SIZE A4